

ESD PROTECTION DIODE

STAND-OFF VOLTAGE – 12 to 24 Volts
POWER DISSIPATION - 150 Watts

GENERAL DESCRIPTION

The L15ESDxVE2 is designed to protect sensitive semiconductor components from damage or upset due to Electro Static Discharge (ESD).

FEATURES

- Uni-directional ESD protection of one line.
- Max. peak pulse power: P_{pp}=150W at t_p = 8/20 us.
- ESD protection >25KV per MIL-STD-883C, method 3015-6 ; class 3.
- IEC 61000-4-2, level 4 (ESD) ; > ±27KV (air) ; ±27KV (contact).

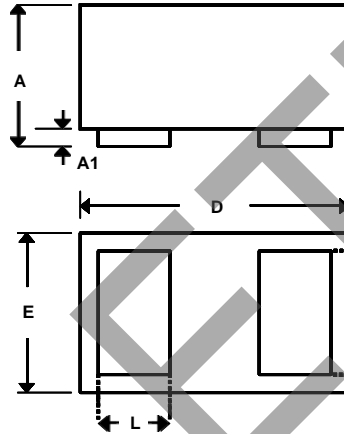
APPLICATION

- Computers and peripherals
- Communication system
- Audio & video equipment
- High-speed data lines
- Parallel ports

MECHANICAL DATA

- Case Material: "Green" molding compound UL flammability classification 94V-0 (No Br, Sb, Cl),
- Component in accordance to RoHs 2011/65/EU
- Dimension = DFN, 1.00 mm (L)* 0.6 mm (W)

SOD-882



SOD-882		
DIM.	MIN.	MAX.
A	0.47	0.53
A1	0.00	0.05
b	0.25	0.55
D	0.95	1.075
E	0.55	0.675
L	0.20	0.45
All dimension in millimeter		

PIN ASSIGNMENT	
1	Cathode
2	Anode

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Peak pulse power (8/20us waveform)	P _{PPM}	150	W
Peak pulse current (8/20us waveform)	I _{PP}	6	A
Operating junction temperature range	T _J	-55 to +125	°C
Storage temperature range	T _{STG}	-55 to +150	°C
Soldering temperature, t max = 10s	T _L	260	°C

REV. 12, Jul.-2016, KSIR29

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ELECTRICAL CHARACTERISTICS

L15ESD12VE2

PARAMETER	TEST CONDITIONS	SYMBOL	MIN	TYP.	MAX	UNIT
Reverse standoff voltage	--	V_{RWM}	--	--	12	V
Reverse leakage current	$V_{DRM} = 12V$	I_{RM}	--	--	50	nA
Breakdown voltage	$I_R = 1\text{ mA}$	V_{BR}	14.2	--	15.8	V
Junction capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$,	C_J	--	45	75	pF
Clamping voltage	$I_{PP} = 6\text{ A}$ (8/20 μs)	V_{CL}	--	--	25	V

L15ESD24VE2

PARAMETER	TEST CONDITIONS	SYMBOL	MIN	TYP.	MAX	UNIT
Reverse standoff voltage	--	V_{RWM}	--	--	24	V
Reverse leakage current	$V_{DRM} = 24V$	I_{RM}	--	--	50	nA
Breakdown voltage	$I_R = 1\text{ mA}$	V_{BR}	26.5	--	29.5	V
Junction capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$,	C_J	--	25	50	pF
Clamping voltage	$I_{PP} = 3\text{ A}$ (8/20 μs)	V_{CL}	--	--	50	V

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**RATING AND CHARACTERISTIC CURVES
L15ESDxVE2**

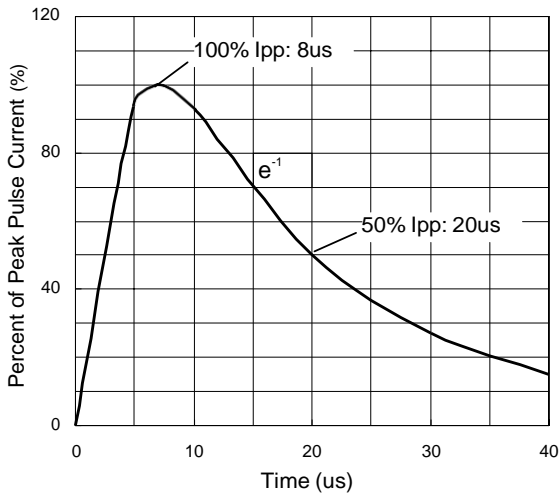


Figure 1. 8/20 us pulse waveform according to IEC 61000-4-5

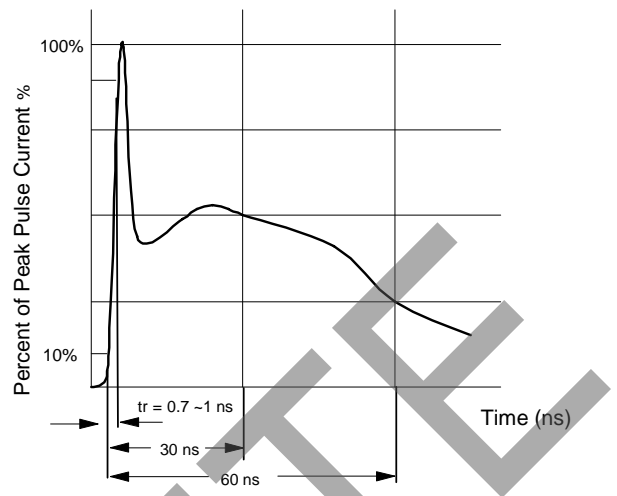


Figure 2. ESD pulse waveform according to IEC 61000-4-2

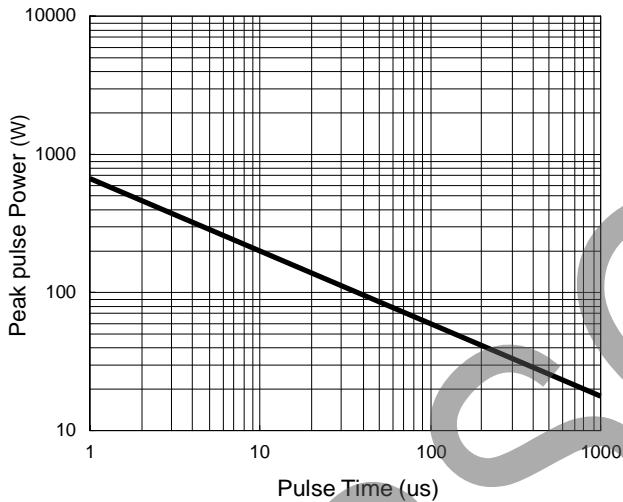


Figure 3. Power Dissipation versus Pulse Time

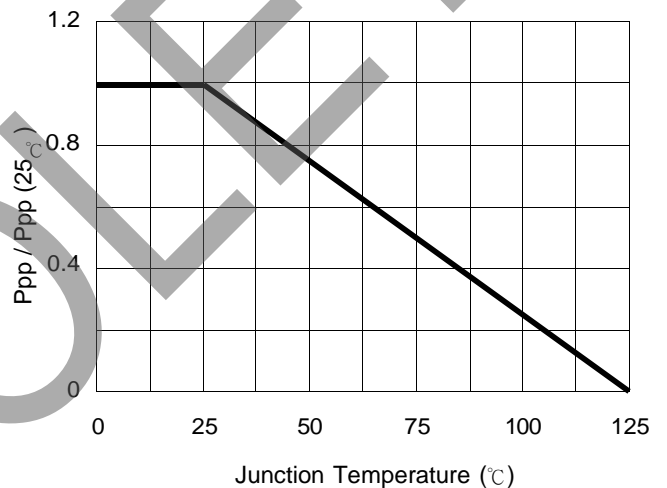


Figure 4. Peak pulse power versus TJ

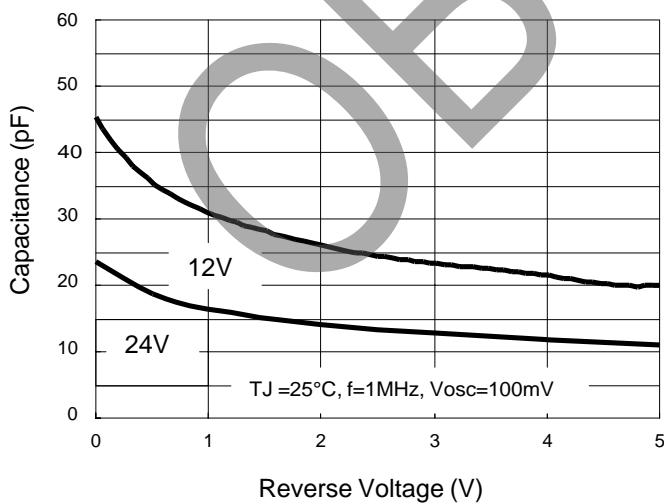


Figure 5. Typical Junction Capacitance

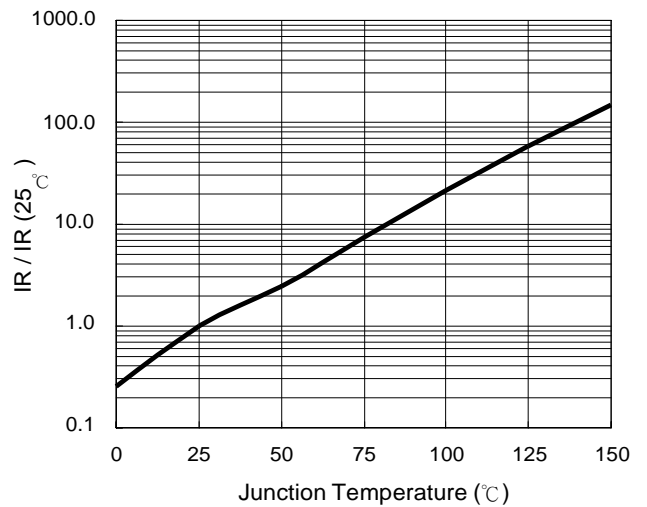


Figure 6. Reverse Leakage Current versus TJ

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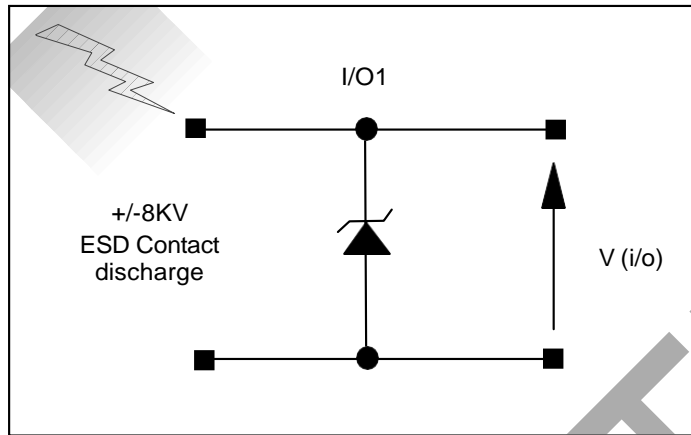


Figure 7. ESD Test Configuration

L15ESD12VE2

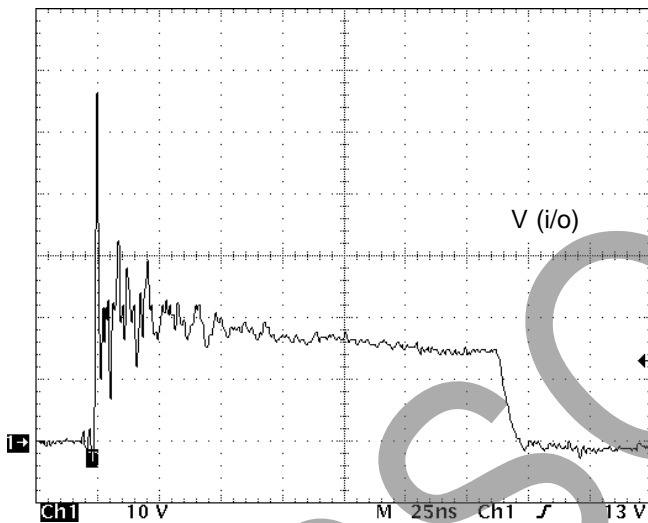


Figure 8. Clamped +8 kV ESD voltage waveform

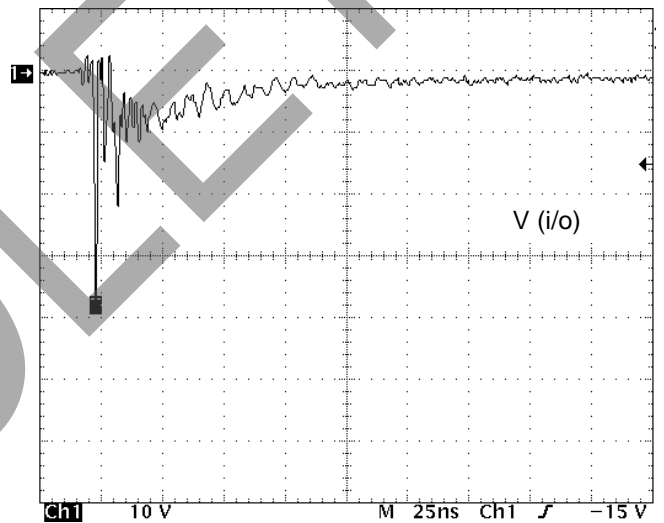


Figure 9. Clamped -8 kV ESD voltage waveform

L15ESD24VE2

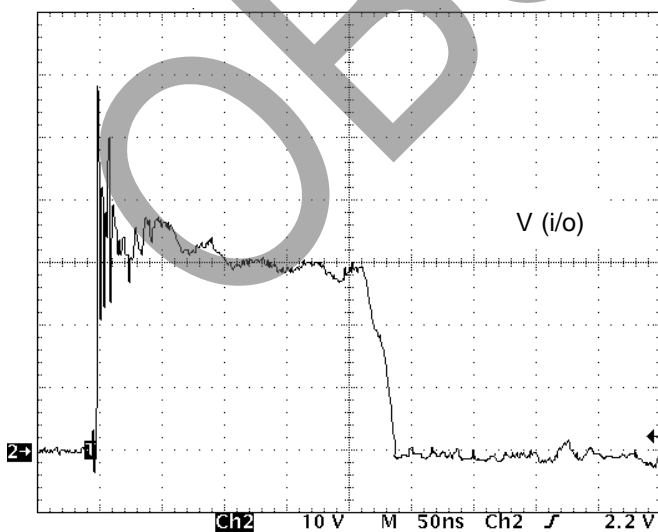


Figure 11. Clamped +8 kV ESD voltage waveform

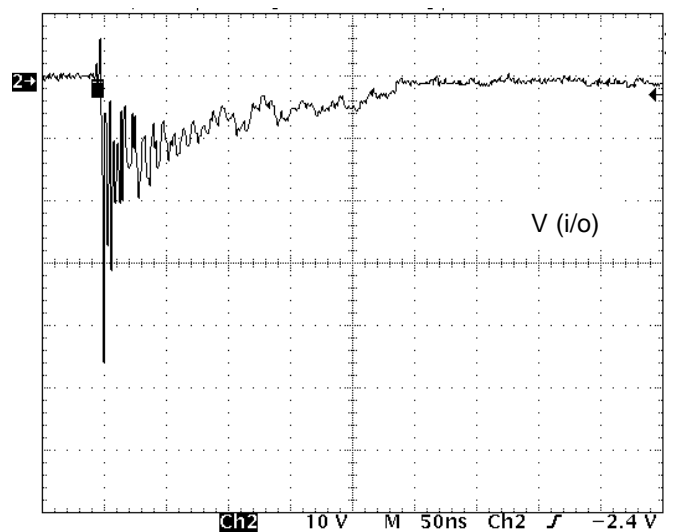


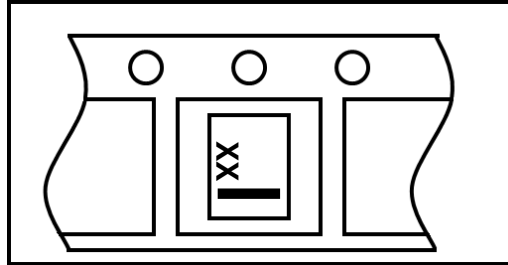
Figure 12. Clamped -8 kV ESD voltage waveform

MARKING AND PACKAGING INFORMATION
L15ESDxVE2



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Marking and Orientation :

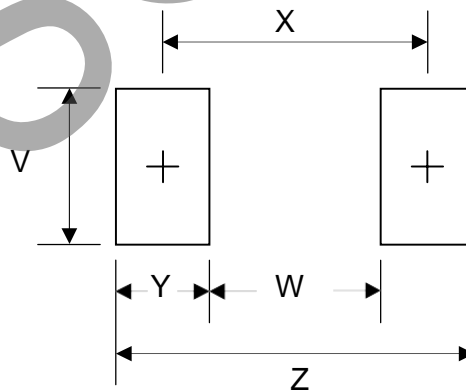


Marking: L15ESD12VE2, XX: MC
 L15ESD24VE2, XX: MO

Packaging Information :

DEVICE	Q'TY/REEL (PCS)	REEL DIA. (INCH)	Q'TY/BOX (PCS)	Q'TY/CARTON (PCS)
L15ESD12VE2 L15ESD24VE2	10K	7	150K	300K

SOD-882 Soldering Pad Layout :



Dim.	Millimeters	Inches
Z	1.30	0.051
X	0.75	0.029
W	0.20	0.007
Y	0.55	0.021
V	0.80	0.031

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